

UNISONIC TECHNOLOGIES CO., LTD

3N65-MH **Preliminary Power MOSFET**

3A, 650V N-CHANNEL POWER MOSFET

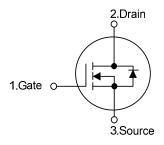
DESCRIPTION

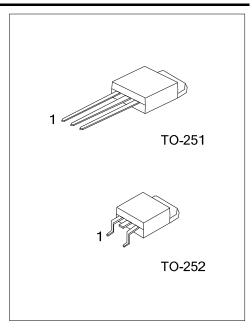
The UTC 3N65-MH is a high voltage power MOSFET combines advanced planar MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

FEATURES

- * $R_{DS(ON)} \le 4.5 \Omega$ @ $V_{GS}=10V$, $I_D=1.0A$
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

SYMBOL

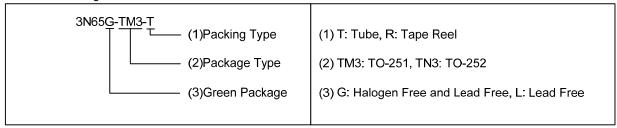




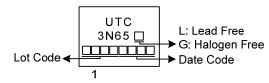
ORDERING INFORMATION

Ordering Number		Daalaaaa	Pin Assignment			Doolsins	
Lead Free	Halogen Free	Package	1	2	3	Packing	
3N65L-TM3-T	3N65G-TM3-T	TO-251	G	D	S	Tube	
3N65L-TN3-R	3N65G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING



www.unisonic.com.tw 1 of 5

■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	V_{DSS}	650	V
Gate-Source Voltage	V_{GSS}	±30	V
Continuous Drain Current	I_{D}	3	Α
Pulsed Drain Current (Note 2)	I_{DM}	6	Α
Avalanche Energy Single Pulsed (Note 3)	E _{AS}	86	mJ
Peak Diode Recovery dv/dt (Note 4)	dv/dt	2.8	V/ns
Power Dissipation	P_{D}	46	W
Junction Temperature	TJ	+150	°C
Storage Temperature	T _{STG}	-55 ~ + 150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 30mH, I_{AS} = 2.4A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD} \le 3.0$ A, di/dt ≤ 200 A/ μ s, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25$ °C

■ THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT	
Junction to Ambient	θ_{JA}	110	°C/W	
Junction to Case	θ_{JC}	2.71 (Note)	°C/W	

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

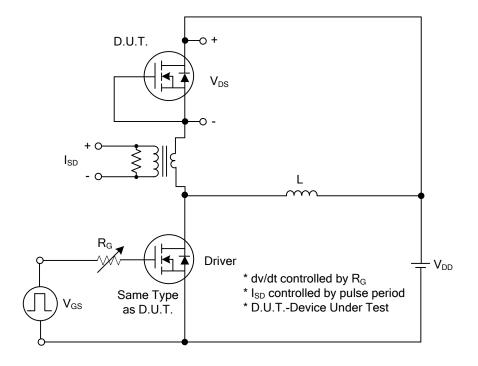
PARAMETER		SYMBOL	TEST CONDITIONS		TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250μA	650			V	
Drain-Source Leakage Current		I _{DSS}	V _{DS} =650V, V _{GS} =0V			10	μΑ	
Gate- Source Leakage Current	Forward	I _{GSS}	V _{GS} =30V, V _{DS} =0V			100	nA	
	Reverse		V _{GS} =-30V, V _{DS} =0V			-100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2.0		4.0	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =1.0A			4.5	Ω	
DYNAMIC CHARACTERISTICS								
Input Capacitance		C _{ISS}			305		pF	
Output Capacitance		Coss	V _{DS} =25V, V _{GS} =0V, f=1.0MHz		35		рF	
Reverse Transfer Capacitance		C _{RSS}			3.3		pF	
SWITCHING CHARACTERISTICS	S							
Total Gate Charge (Note 1)		Q_G	\\ _520\\ \\ _40\\ _24		8.5		nC	
Gate-Source Charge		Q_GS	V_{DS} =520V, V_{GS} =10V, I_{D} =3A I_{G} =1mA (Note 1, 2)		3.2		nC	
Gate-Drain Charge		Q_{GD}	IG-IIIA (Note 1, 2)		1.5		nC	
Turn-On Delay Time (Note 1)		t _{D(ON)}			5		ns	
Turn-On Rise Time		t _R	V _{DS} =100V, V _{GS} =10V, I _D =3A,		16		ns	
Turn-Off Delay Time		t _{D(OFF)}	R _G =25Ω (Note 1, 2)		21		ns	
Turn-Off Fall Time		t _F			20		ns	
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS								
Maximum Body-Diode Continuous Current		Is				3	Α	
Maximum Body-Diode Pulsed Current		I _{SM}				6	Α	
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I_S =3A , V_{GS} =0V			1.4	V	
Reverse Recovery Time (Note 1)		t _{rr}	I_S =3A , V_{GS} =0V		260		ns	
Reverse Recovery Charge		Qrr	di/dt=100A/μs		2.7		μC	

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

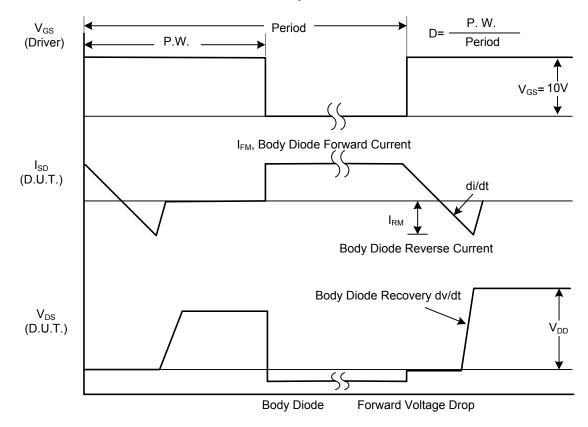
2. Essentially independent of operating temperature.



■ TEST CIRCUITS AND WAVEFORMS

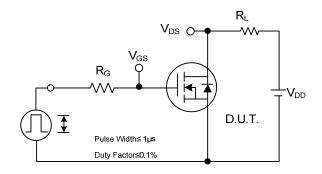


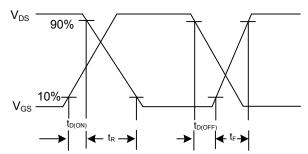
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

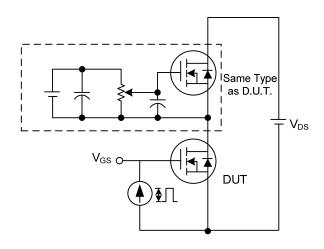
TEST CIRCUITS AND WAVEFORMS

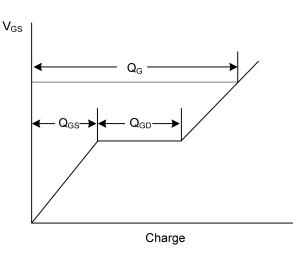




Switching Test Circuit

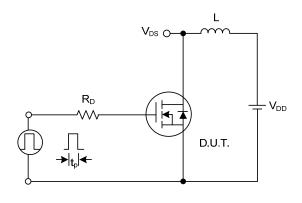
Switching Waveforms

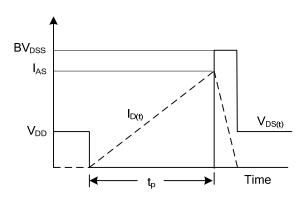




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

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